

🌐 Peru 📅 October 15-17, 2025

CONFERENCE WEBSITE: <https://icacit.org.pe/symposium/>

| About the Conference

The 11th International Symposium on Accreditation of Engineering and Computing Education - 2025 ICACIT Symposium is the most important educational quality and accreditation event in Latin America. A space to share knowledge and experiences in accreditation, education, and continuous quality improvement among professionals from academia, industry and government. The event will be held in Hybrid modality.

Important Dates

 **OCT 15** CONFERENCE DATE
October 15-17, 2025

All papers must be original and not simultaneously submitted to another journal or conference.

Preparing Your Full Paper:

The official language is English..

One paper must have a maximum of six (6) authors.

The papers must be presented in PDF maximum length is six (6) pages per article including illustrations and references following the IEEE format for conferences, available at:

<https://www.ieee.org/conferences/publishing/templates.html>.Microsoft Word

US letter (DOC, 30 KB) Updated Jan 2019

A4 (DOC, 30 KB) Updated Jan 2019

LaTeX Template Instructions (PDF, 63 KB) [Be sure to use the template's conference mode.]

Template (ZIP, 700 KB) Updated October 2019

LaTeX Bibliography Files (ZIP, 309 KB)

List of Topics

Quality Assurance and Accreditation.Relationship of Students.

Professors and Programs with Industry.

Government, Society and Academia.

Artificial intelligence in educational and learning environments.

Ethical challenges.Digital Transformation in Higher Education.

Game-based learning and gamification.Non-traditional laboratory.

Virtual and remote laboratories and classrooms.Education in the era of Industry 5.0.

Program Committee

General Chair: Jimmy Túllume Salazar (Perú)

Technical Program Chair: Edmundo Tovar Caro (España)

Local Organizing Chair: Victor Tuesta Monteza (Perú)

Publication

All papers in English accepted and presented

orally at ICACIT Symposium 2025 will be included in the conference proceedings and submitted for publication to the IEEE Xplore®. Content of IEEE Xplore® is made available to its abstracting and indexing partners, Scopus, for potential inclusion in their respective databases.

Publication in IEEE Xplore 2017:

<https://ieeexplore.ieee.org/xpl/mostRecentIssue.jsp?punumber=8356603>

Publication in IEEE Xplore 2019:

<https://ieeexplore.ieee.org/xpl/conhome/9124622/proceeding>

Publication in IEEE Xplore 2020:

<https://ieeexplore.ieee.org/xpl/conhome/9276405/proceeding>

Publication in IEEE Xplore 2021:

<https://ieeexplore.ieee.org/xpl/conhome/9612424/proceeding>

Publication in IEEE Xplore 2022:

<https://ieeexplore.ieee.org/xpl/conhome/10041433/proceeding>

Publication in IEEE Xplore 2023:

<https://ieeexplore.ieee.org/xpl/conhome/10403656/proceeding>

Publication in IEEE Xplore 2024:

<https://ieeexplore.ieee.org/xpl/conhome/10788424/proceeding>

Venue

The conference will be held at the Señor de Sipán University (USS) located in the district of Pimentel, province of Chiclayo, in the Lambayeque region. It was established on July 5, 1999, following the authorization granted by the then National Council for the Authorization and Operation of Universities (Conafu), according to Resolution No. 575-99-Conafu. Regarding its name, the USS is named after a pre-Hispanic ruler from the ancient Mochica culture, known as the “Lord of Sipán.”

The conference will be held in the city Chiclayo, the "City of Friendship" in northern Peru, enchants visitors with culture, history, and warm hospitality. Nestled in the Lambayeque region, Chiclayo offers a captivating mix of ancient heritage and contemporary energy. Discover its remarkable archaeological treasures, such as the Lord of Sipán tomb, indulge in its celebrated gastronomy. A visit to Chiclayo promises an unforgettable journey into the heart of Peruvian culture.

TOPICS OF INTEREST

3 topics

Research papers are invited in, but not limited to, the following areas:

Multidisciplinary
& General

Uncategorized

Artificial
Intelligence &
Machine Learning